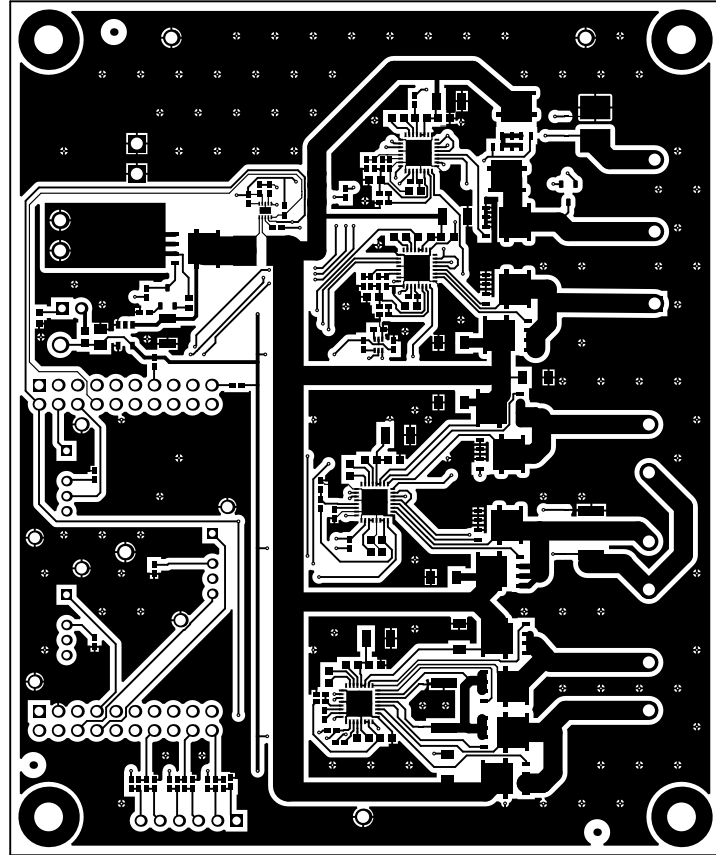
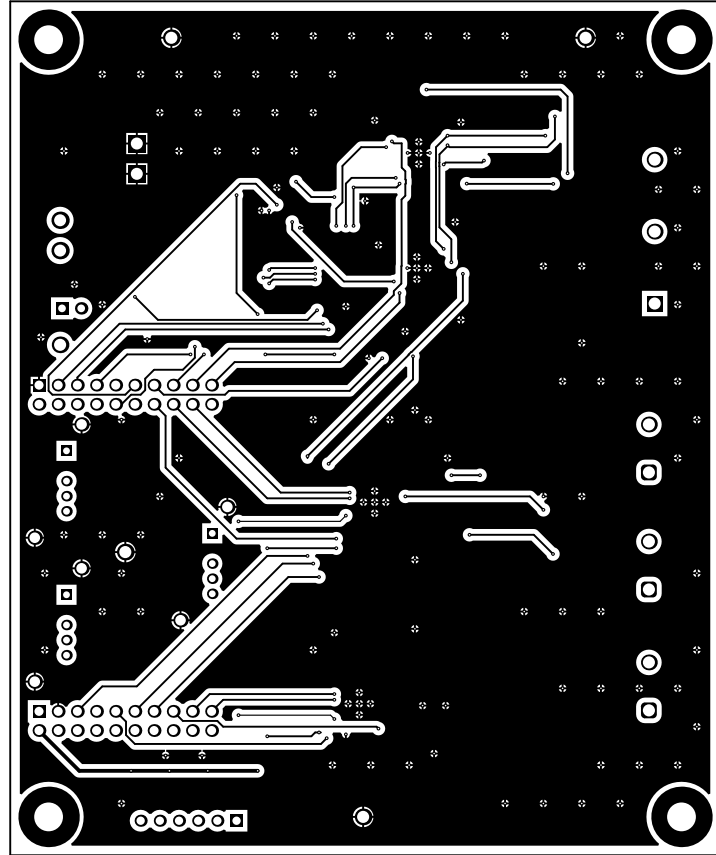


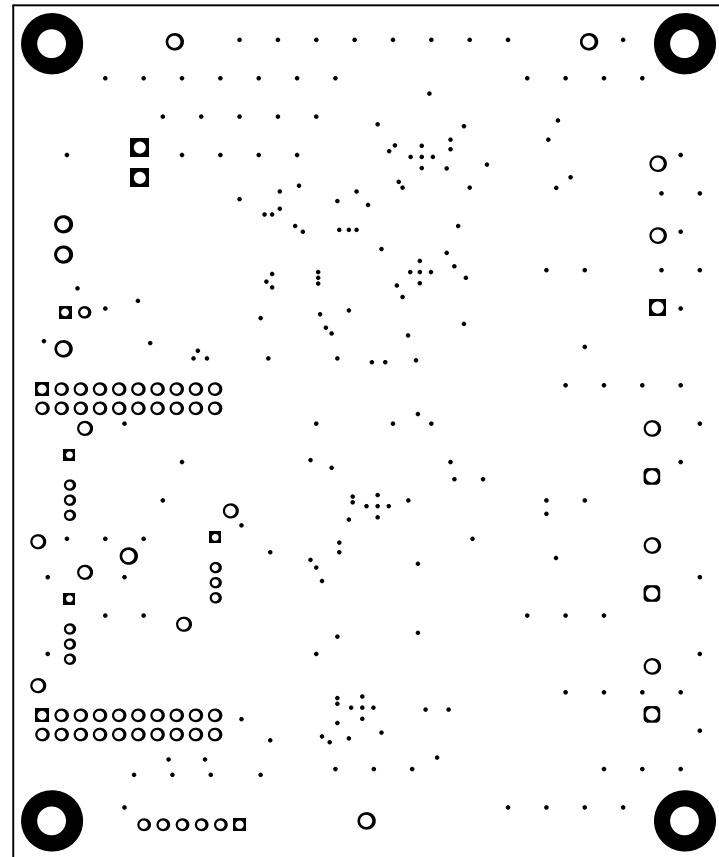
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01530	REV: E3	SUN REV: Not In VersionControl
LAYER NAME = Top Solder	TID #: 01530		
PLOT NAME = Top Solder Mask	GENERATED : 1/4/2018	1:00:15 PM	TEXAS INSTRUMENTS



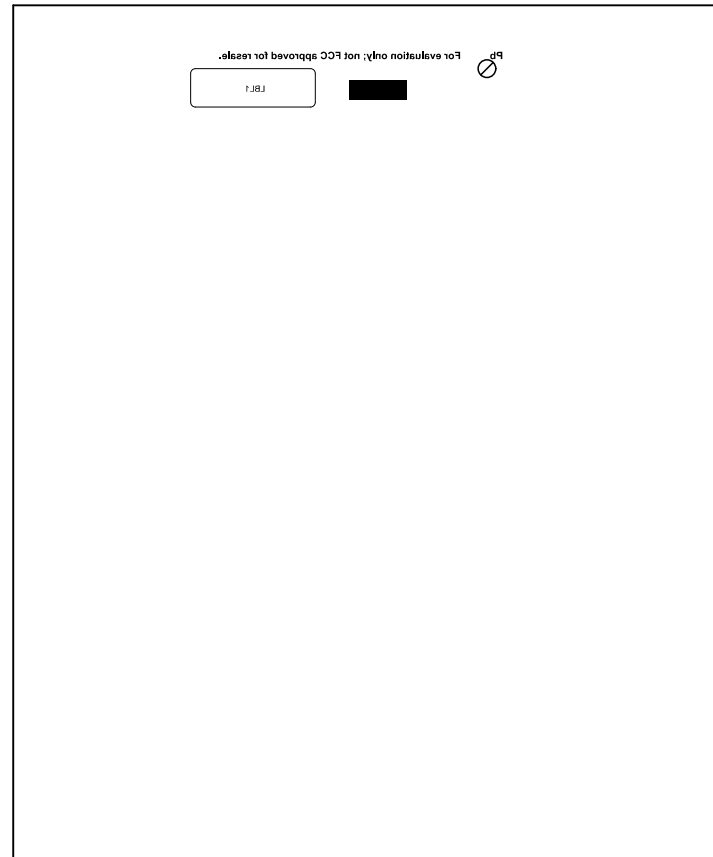
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01530	REV: E3	SUN REV: Not In VersionControl
LAYER NAME = Top Layer	TID #: 01530		
PLOT NAME = Top Layer	GENERATED : 1/4/2018	1:00:16 PM	TEXAS INSTRUMENTS



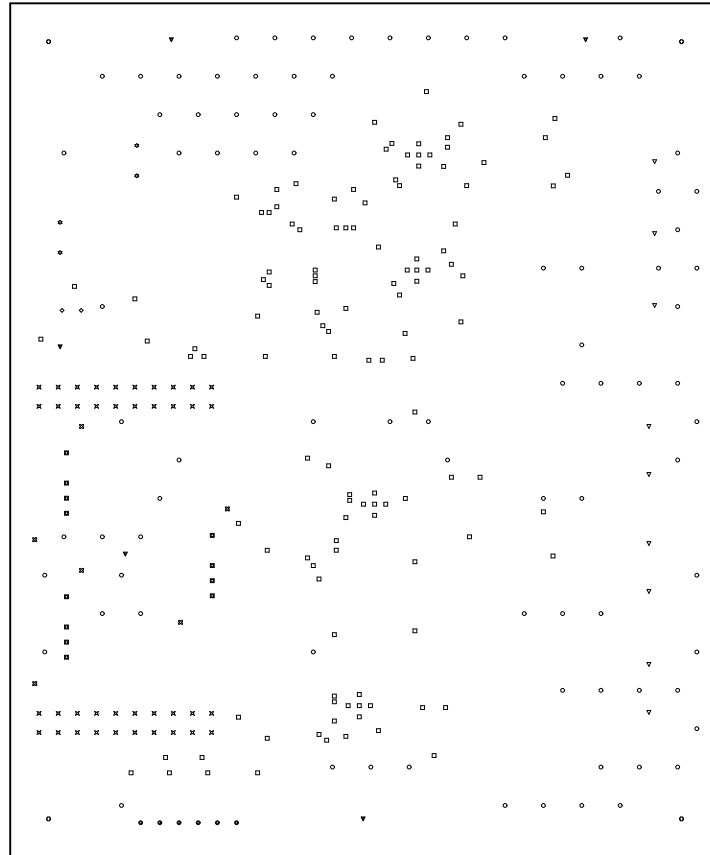
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01530	REV: E3	SUN REV: Not In VersionControl
LAYER NAME = Bottom Layer	TID #: 01530		
PLOT NAME = Bottom Layer	GENERATED : 1/4/2018	1:00:18 PM	TEXAS INSTRUMENTS



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01530	REV: E3	SUN REV: Not In VersionControl
LAYER NAME = Bottom Solder	TID #: 01530		
PLOT NAME = Bottom Solder Mask	GENERATED : 1/4/2018	1:00:20 PM	TEXAS INSTRUMENTS

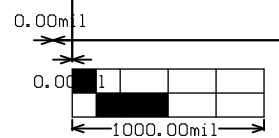
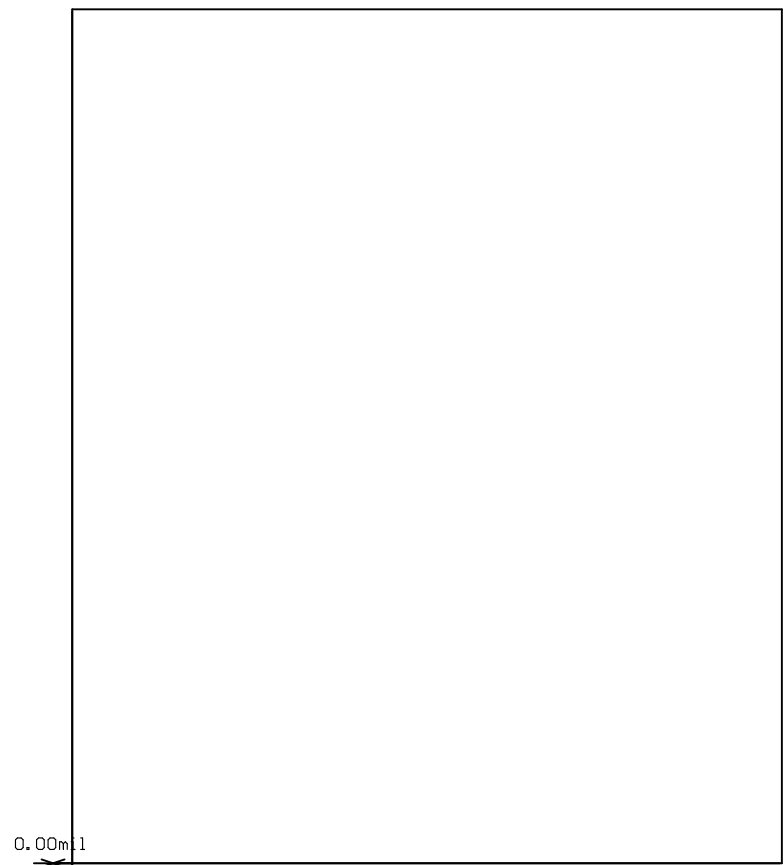


ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01530	REV: E3	SUN REV: Not In VersionControl
LAYER NAME = Bottom Overlay	TID #: 01530		
PLOT NAME = Bottom Overlay	GENERATED : 1/4/2018	1:00:21 PM	TEXAS INSTRUMENTS



Symbol	Quantity	Finished Hole Size	Plated	Hole Type	Drill Layer Pair	Hole Tolerance
□	122	7.87mil (0.200mm)	PTH	Round	Top Layer - Bottom Layer	
○	86	8.00mil (0.203mm)	PTH	Round	Top Layer - Bottom Layer	
■	12	35.43mil (0.900mm)	PTH	Round	Top Layer - Bottom Layer	
◇	2	40.00mil (1.016mm)	PTH	Round	Top Layer - Bottom Layer	
●	6	43.31mil (1.100mm)	PTH	Round	Top Layer - Bottom Layer	
⊗	40	47.24mil (1.200mm)	PTH	Round	Top Layer - Bottom Layer	
⊗	6	55.12mil (1.400mm)	PTH	Round	Top Layer - Bottom Layer	
☆	4	62.50mil (1.587mm)	PTH	Round	Top Layer - Bottom Layer	
▽	9	62.99mil (1.600mm)	PTH	Round	Top Layer - Bottom Layer	
▽	5	63.00mil (1.600mm)	PTH	Round	Top Layer - Bottom Layer	
⊕	4	150.00mil (3.810mm)	PTH	Round	Top Layer - Bottom Layer	
	296 Total					

ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01530	REV: E3	SUN REV: Not In VersionControl
LAYER NAME = Drill Drawing	TID #: 01530		
PLOT NAME = Drill Drawing	GENERATED : 1/4/2018	1:00:23 PM	TEXAS INSTRUMENTS



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01530	REV: E3	SUN REV: Not In VersionControl
LAYER NAME = M2 Board Dimensions	TID #: 01530		
PLOT NAME = Board Dimensions	GENERATED : 1/4/2018 1:00:25 PM	TEXAS INSTRUMENTS	

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